

Schottky rectifier

Datasheet - production data



Description

Single Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in SOD-123, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications. Due to the small size of the package this device fits GSM and PCMCIA requirements.

Table 1. Device summary

I _{F(AV)}	0.5 A
V_{RRM}	30 V
V _F (max)	0.33 V

Features

- · Very small conduction losses
- · Negligible switching losses
- · Extremely fast switching

Characteristics STPS0530Z

Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage	30	V		
I _{F(RMS)}	Forward rms current	2	Α		
I _{F(AV)}	Average forward current $\delta = 0.5$	0.5	Α		
I _{FSM}	Surge non repetitive forward current	5.5	Α		
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs		
T _{stg}	Storage temperature range	-65 to +150	°C		
Tj	Operating junction temperature range ⁽¹⁾	-40 to +150	°C		
T _L	Maximum temperature for soldering duri	260	°C		

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit	
R _{th(j-a)}	Junction to ambient	340 ⁽¹⁾	°C/W	

^{1.} Copper area on PCB $S = 2.5 \text{ mm}^2$

Table 4. Static electrical characteristics

Symbol	Parameter	Test con	Тур.	Max.	Unit	
ı (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	\/ 4E\/		12	μΑ
		T _j = 125 °C	V _R = 15 V	3	5	mA
'R`		T _j = 25 °C	$V_R = V_{RRM}$		130	μΑ
		T _j = 125 °C		9	21	mA
V _F ⁽²⁾ Forward vo		T _j = 25 °C			0.375	V
	Forward voltage drop	T _j = 125 °C	I _F = 0.1 A	0.20	0.22	
		T _j = 25 °C	I 05 A		0.43	
		T _j = 125 °C	I _F = 0.5 A	0.31	0.33	

^{1.} Pulse test: $tp = 5 \text{ ms}, \delta < 2\%$

To evaluate the maximum conduction losses use the following equation: P = 0.23 x $\rm I_{F(AV)}$ + 0.18 $\rm I_{F}^2_{(RMS)}$

$$P = 0.23 \times I_{F(\Delta V)} + 0.18 I_{F(RMS)}^{2}$$

^{2.} Pulse test: $tp = 380 \mu s$, $\delta < 2\%$

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Figure 1. Conduction losses versus average current

PF(AV)(W) 0.22 $-\delta = 0.1 - \delta = 0.2$ $-\delta = 0.05$ 0.20 0.18 0.16 0.14 0.12 0.10 0.08 0.06 0.04 0.02 $\delta = tp/T$ 0.00 0.0

Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$)

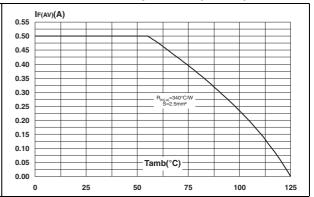
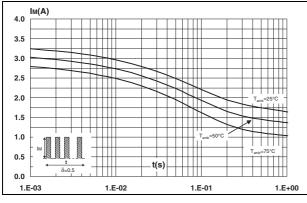


Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration



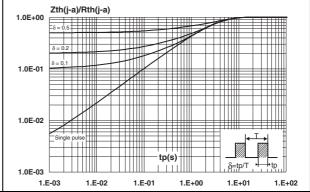


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

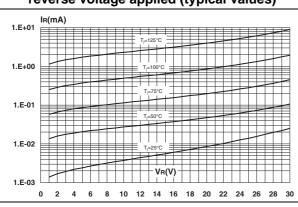
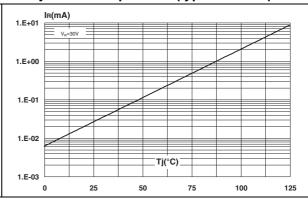


Figure 6. Reverse leakage current versus junction temperature (typical values)



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Figure 7. Junction capacitance versus reverse Figure 8. Forward voltage drop versus forward voltage applied (typical values) current

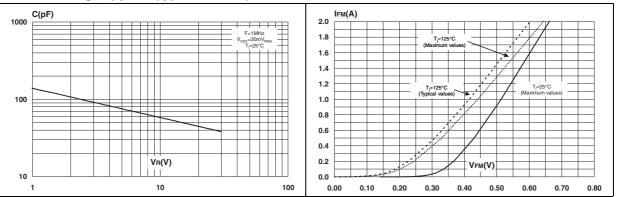
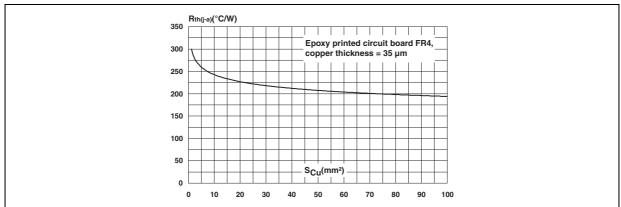


Figure 9. Thermal resistance junction to ambient versus copper surface under each lead (typical values)



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STPS0530Z Package information

2 Package information

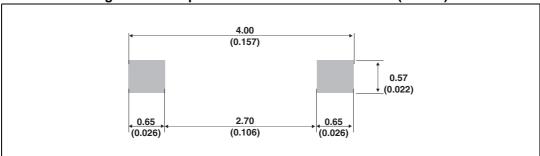
- Epoxy meets UL94, V0.
- Band indicates cathode.

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Dimensions Ref Millimeters Inches Min. Max. Min. Max. Α 1.45 0.057 Α1 0 0.1 0 0.004 Α2 0.85 1.35 0.033 0.053 b 0.55 Typ. 0.022 Typ. 0.15 Typ. 0.039 Typ. С 2.55 D 2.85 0.1 0.112 Ε 1.4 1.7 0.055 0.067 G 0.25 0.01 Н 3.55 0.14 0.1148 3.75

Table 5. SOD-123 dimensions





Ordering information STPS0530Z

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS0530Z	Z53	SOD-123	0.01 g	3000	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
Mar-2003	1A	Initial release.
		Reformated to current standards. Updated maximum junction temperatures to 150 °C and updated package illustration to show cathode bar on page 1
23-Apr-2014	3	Updated Tj max to Tj range in <i>Table 2</i> .

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